

**General Description**

The SJT02N170 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a wide variety of applications.

Features

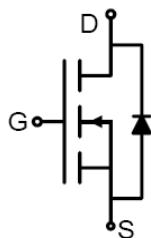
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Unit
V_{DS}	200	V
$R_{DS(ON)}_{TYP}$	16.7	mΩ
I_D	77	A
Q_G	134	nC



Schematic Diagram

TO-247 top view

Device/Ordering Code	Marking	Package	Reel Size	Tape width	Quantity
SJT02N170	SJT02N170	TO-247	\	\	\

Table 1. Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0\text{V}$)	200	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0\text{V}$)	± 20	V
I_D	Drain Current-Continuous($T_c=25^\circ\text{C}$)	77	A
	Drain Current-Continuous($T_c=100^\circ\text{C}$)	49	A
I_{DM} (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	308	A
P_D	Maximum Power Dissipation($T_c=25^\circ\text{C}$)	313	W
	Maximum Power Dissipation($T_c=100^\circ\text{C}$)	125	W
E_{AS}	Avalanche energy (Note 2)	1190	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
R_{eJC}	Thermal Resistance, Junction-to-Case		0.4	°C/W



200V N-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$	200			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=150\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			1	μA
		$V_{\text{DS}}=150\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$			± 100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$	3		5	V
g_{FS}	Forward Transconductance	$V_{\text{DS}}=10\text{V}$, $I_{\text{D}}=20\text{A}$		73		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=40\text{A}$ $T_J=25^\circ\text{C}$		16.7	21	$\text{m}\Omega$
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=50\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1.0\text{MHz}$		8826		pF
C_{oss}	Output Capacitance			532		pF
C_{rss}	Reverse Transfer Capacitance			148		pF
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $f=1.0\text{MHz}$		1.2		Ω
Switching Parameters						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=50\text{V}$, $R_{\text{L}}=1.25\Omega$, $R_{\text{GEN}}=3\Omega$		36.3		nS
t_r	Turn-on Rise Time			9.2		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			64		nS
t_f	Turn-Off Fall Time			6.3		nS
Q_g	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=50\text{V}$, $I_{\text{D}}=40\text{A}$		134		nC
Q_{gs}	Gate-Source Charge			49.6		nC
Q_{gd}	Gate-Drain Charge			39.6		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				77	A
V_{SD}	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=20\text{A}$			1.2	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=40\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		102		ns
Q_{rr}	Reverse Recovery Charge	$I_{\text{F}}=40\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		550.3		nC

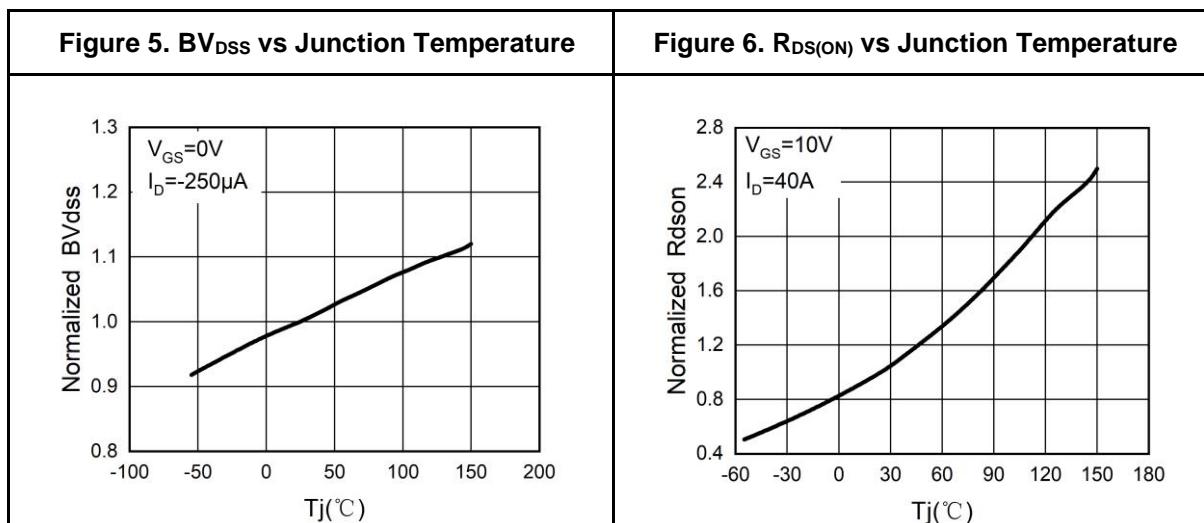
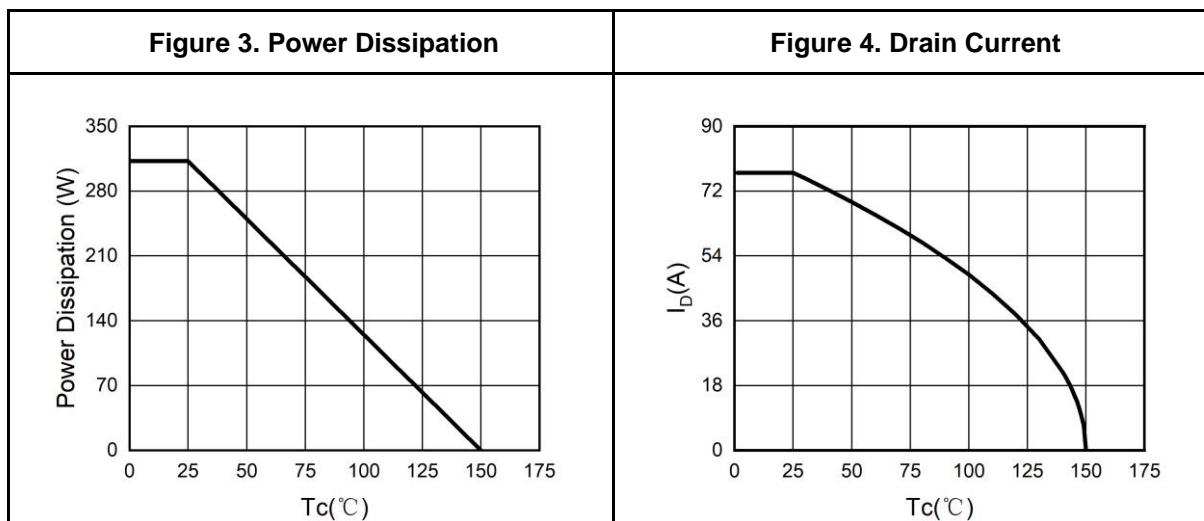
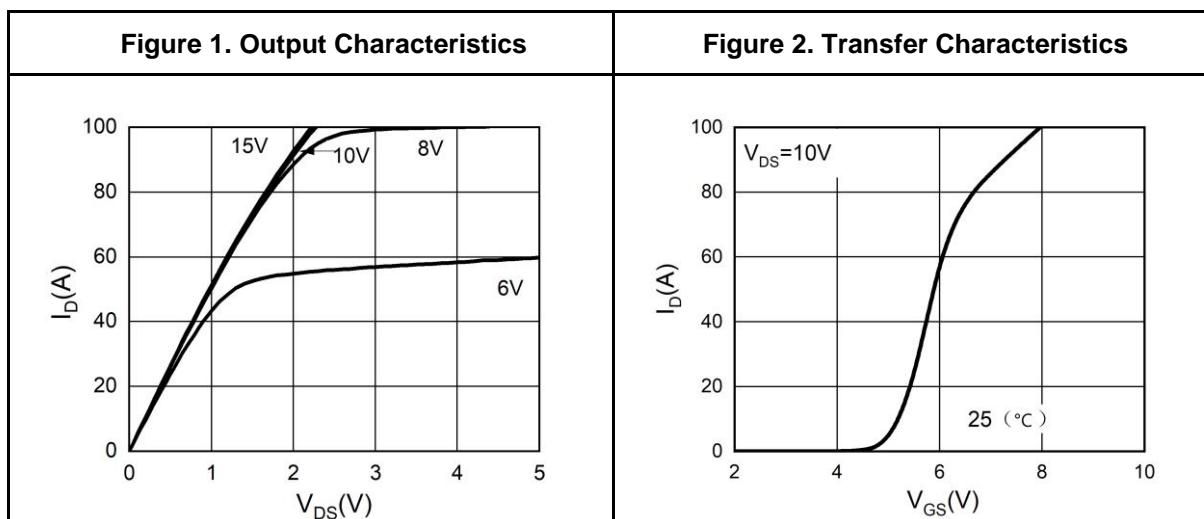
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: $T_J=25^\circ\text{C}$, $V_{\text{DD}}=40\text{V}$, $V_{\text{G}}=10\text{V}$, $R_g=25\Omega$, $L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

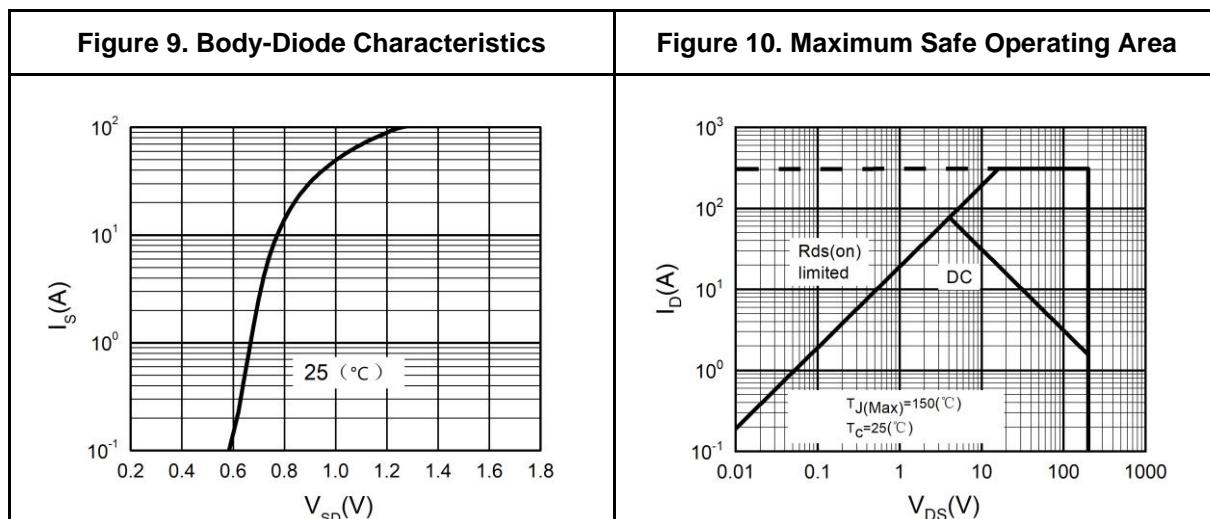
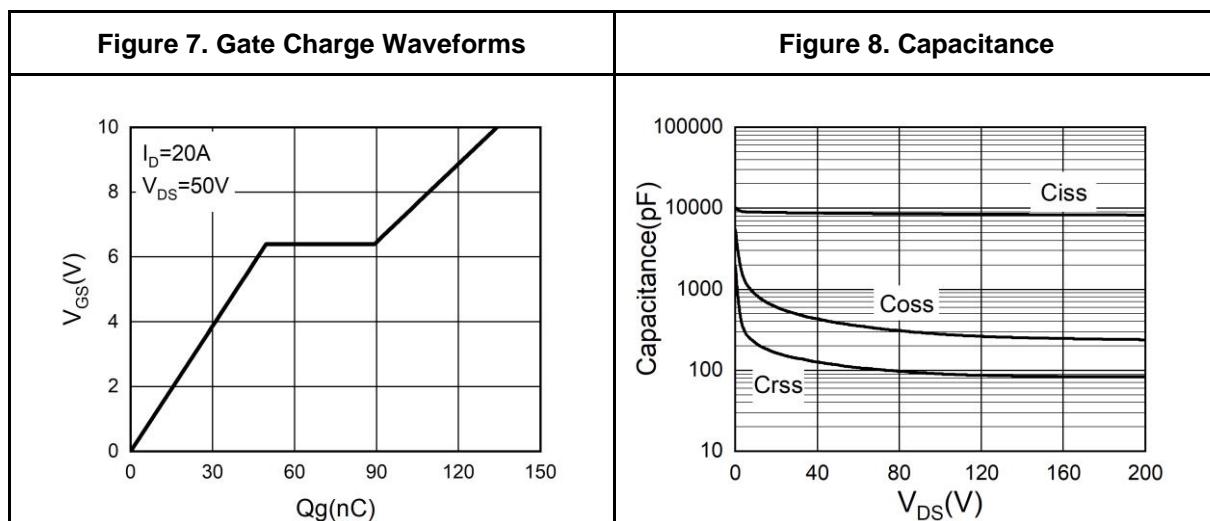


Typical Electrical And Thermal Characteristics (Curves)



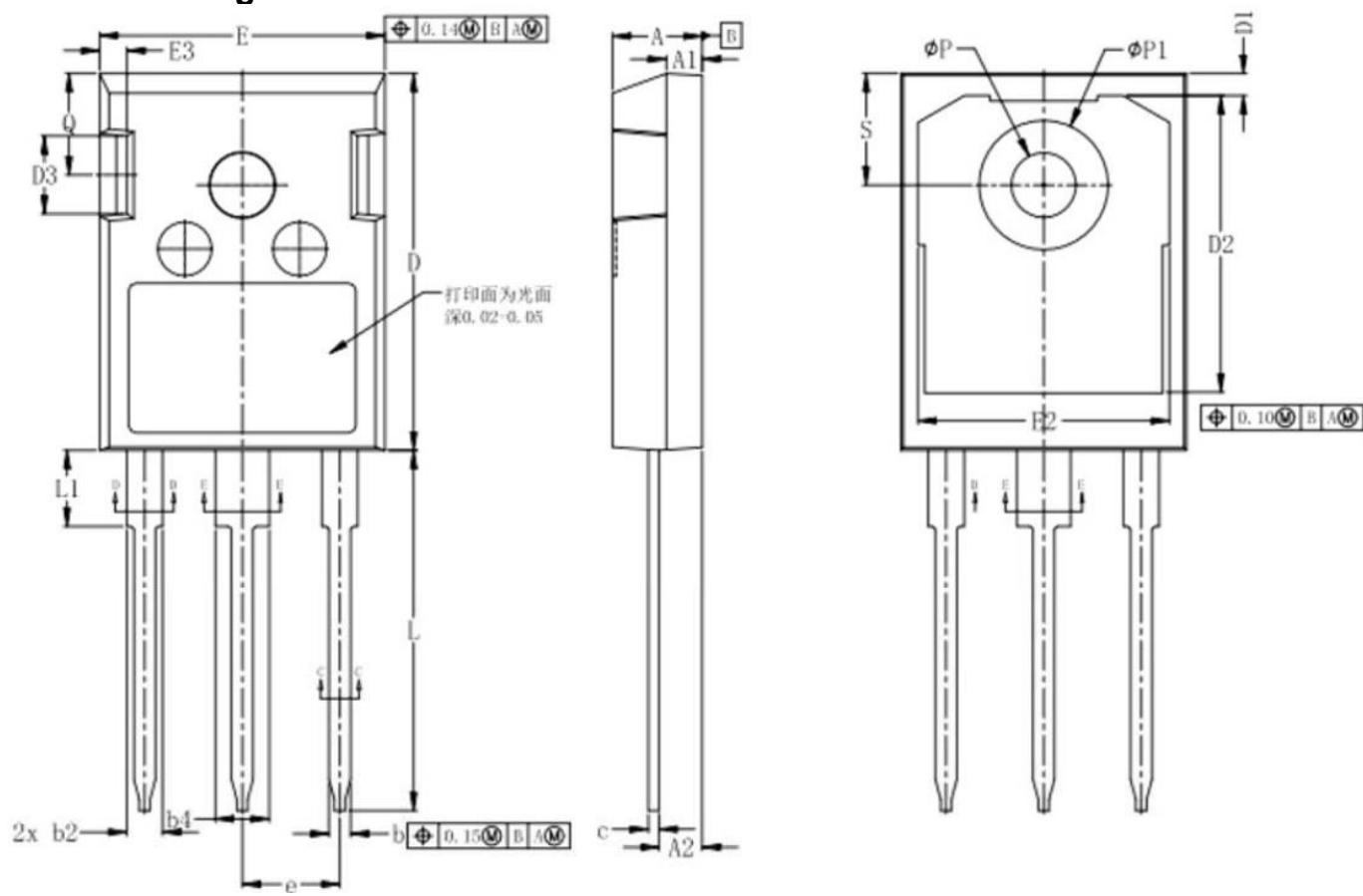


Typical Electrical And Thermal Characteristics (Curves)





TO-247 Package Information



DIM / SYMBOL	MIN.	NOM.	MAX.
A	4.900	5.000	5.100
A1	1.940	2.040	2.140
A2	2.300	2.400	2.500
b	1.139	1.239	1.330
b1	1.099	1.199	1.299
b2	1.939	2.039	2.139
b3	1.899	1.999	2.099
b4	2.940	3.040	3.140
b5	2.900	3.000	3.100
c	0.550	0.640	0.700
c1	0.500	0.600	0.700
D	20.850	20.950	21.050
D1	1.022	1.222	1.400
D2	16.348	16.548	16.748
D3	4.232	4.332	4.432
E	15.800	15.900	16.000
E2	13.821	14.021	14.221
E3	1.430	1.530	1.630
e	5.436 BSC.		
L	19.900	20.100	20.300
L1	4.024	4.224	4.424
P	3.500	3.600	3.700
P1	7.088	7.188	7.288
Q	5.435	5.635	5.835
S	6.040	6.200	6.300



200V N-Channel Trench Power MOSFET

Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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